

SGM321 SGM358 SGM324

1MHz, 60 μ A, Rail-to-Rail I/O CMOS Operational Amplifier

PRODUCT DESCRIPTION

The SGM321(single), SGM358(dual) and SGM324(quad) are rail-to-rail input and output voltage feedback amplifiers offering low cost. They have a wide input common-mode voltage range and output voltage swing, and take the minimum operating supply voltage down to 2.1V and the maximum recommended supply voltage is 5.5 V. All are specified over the extended -40°C to $+85^{\circ}\text{C}$ temperature range.

The SGM321/358/324 provide 1MHz bandwidth at a low current consumption of 60 μA per amplifier. Very low input bias currents of 10pA, enable SGM321/358/324 to be used for integrators, photodiode amplifiers, and piezoelectric sensors. Rail-to-rail inputs and outputs are useful to designers buffering ASIC in single-supply systems.

Applications for the series amplifiers include safety monitor- ing, portable equipment, battery and power supply control, and signal conditioning and interfacing for transducers in very low power systems.

The SGM321 is available in SOT23-5 and SC70-5 packages. The SGM358 comes in SO-8, MSOP-8 and PDIP-8 packages. The SGM324 is offered in SO-14, SO-16, TSSOP-14 and TSSOP-16 packages.

APPLICATIONS

ASIC Input or Output Amplifier
Sensor Interface
Piezo Electric Transducer Amplifier
Medical Instrumentation
Mobile Communication
Audio Output
Portable Systems
Smoke Detectors
Notebook PC
PCMCIA cards
Battery -Powered equipment
DSP interface

FEATURES

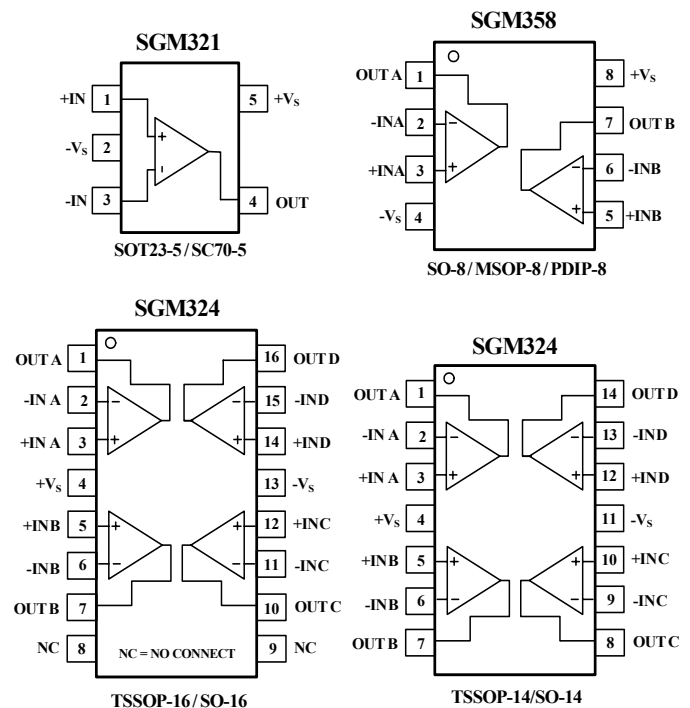
- Low Cost
- Rail-to-Rail Input and Output
0.8mV Typical V_{OS}
- Unity Gain Stable
- Gain Bandwidth Product: 1MHz
- Very Low Input Bias Currents: 10pA
- Operates on 2.1 V to 5.5 V Supplies
- Input Voltage Range:
 -0.1 V to $+5.6\text{ V}$ with $V_S = 5.5\text{ V}$
- Low Supply Current: 60 μA /Amplifier
- Small Packaging

SGM321 Available in SOT23-5 and SC70-5

SGM358 Available in SO-8, MSOP-8 and PDIP-8

SGM324 Available in SO-14, SO-16, TSSOP-14 and TSSOP-16

PIN CONFIGURATIONS (Top View)



ELECTRICAL CHARACTERISTICS : $V_S = +5V$

(At $R_L = 100k\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, unless otherwise noted)

PARAMETER	CONDITION	SGM321/358/324				
		TYP	MIN/MAX OVER TEMPERATURE			
		+25℃	+25℃	-40℃ to 85℃	UNITS	MIN / MAX
INPUT CHARACTERISTICS						
Input Offset Voltage (V _{OS})	V _S = 5.5V V _S = 5.5V, V _{CM} = - 0.1V to 4 V V _S = 5.5V, V _{CM} = - 0.1V to 5.6 V R _L = 5KΩ ,Vo = 0.1V to 4.9V R _L =100KΩ ,Vo = 0.035V to 4.965V	±0.8	±5	±5.6	mV	MAX
Input Bias Current (I _B)		10			pA	TYP
Input Offset Current (I _{OS})		10			pA	TYP
Common-Mode Voltage Range (V _{CM})		- 0.1 to + 5.6			V	TYP
Common-Mode Rejection Ratio(CMRR)		70	62	62	dB	MIN
		68	56	55	dB	MIN
Open-Loop Voltage Gain(A _{OL})		80	70	70	dB	MIN
		84	80	80	dB	MIN
Input Offset Voltage Drift (ΔV _{OS} /ΔT)		2.7			μV/℃	TYP
OUTPUT CHARACTERISTICS						
Output Voltage Swing from Rail	R _L = 100KΩ	0.008			V	TYP
	R _L = 10KΩ	0.08			V	TYP
Output Current (I _{OUT})		23	20	18.8	mA	MIN
POWER SUPPLY						
Operating Voltage Range	V _S = +2.5 V to + 5.5 V V _{CM} = (-V _S) + 0.5 I _{OUT} = 0		2.1 5.5	2.5 5.5	V V	MIN MAX
Power Supply Rejection Ratio (PSRR)		82	60	58	dB	MIN
Quiescent Current / Amplifier (I _Q)		60	80	86	μA	MAX
DYNAMIC PERFORMANCE						
Gain-Bandwidth Product (GBP)	C _L = 100pF	1			MHz	TYP
Slew Rate (SR)	G = +1 , 2V Output Step	0.52			V/μs	TYP
Settling Time to 0.1%(t _s)	G = +1, 2 V Output Step	5.3			μs	TYP
Overload Recovery Time	V _{IN} ·Gain = Vs	2.6			μs	TYP
NOISE PERFORMANCE						
Voltage Noise Density (e _n)	f = 1kHz	27			nV/√Hz	TYP
	f = 10kHz	20			nV/√Hz	TYP

Specifications subject to change without notice.

PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION
SGM321	SGM321YC5/TR	SC70-5	Tape and Reel, 3000	321
	SGM321YN5/TR	SOT23-5	Tape and Reel, 3000	321
SGM358	SGM358YS/TR	SO-8	Tape and Reel, 2500	SGM358YS
	SGM358YMS/TR	MSOP-8	Tape and Reel, 3000	SGM358YMS
	SGM358YP	PDIP-8	Tube, 50	SGM358YP
SGM324	SGM324YS/TR	SO-16	Tape and Reel, 2500	SGM324YS
	SGM324YTS/TR	TSSOP-16	Tape and Reel, 3000	SGM324YTS
	SGM324YS14/TR	SO-14	Tape and Reel, 2500	SGM324YS14
	SGM324YTS14/TR	TSSOP-14	Tape and Reel, 3000	SGM324YTS14

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_+ to V_- 7.5 V

Common-Mode Input Voltage

..... $(-V_s) - 0.5 \text{ V to } (+V_s) + 0.5 \text{ V}$

Storage Temperature Range $-65^\circ\text{C to } +150^\circ\text{C}$

Junction Temperature 160°C

Operating Temperature Range $-45^\circ\text{C to } +85^\circ\text{C}$

Package Thermal Resistance @ $T_A = 25^\circ\text{C}$

SC70-5, θ_{JA} 333°C/W

SOT23-5, θ_{JA} 190°C/W

SO-8, θ_{JA} 125°C/W

MSOP-8, θ_{JA} 216°C/W

SO-16, θ_{JA} 82°C/W

TSSOP-16, θ_{JA} 105°C/W

Lead Temperature Range (Soldering 10 sec)

..... 260°C

ESD Susceptibility

HBM 4000 V

MM 400 V

NOTES

1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

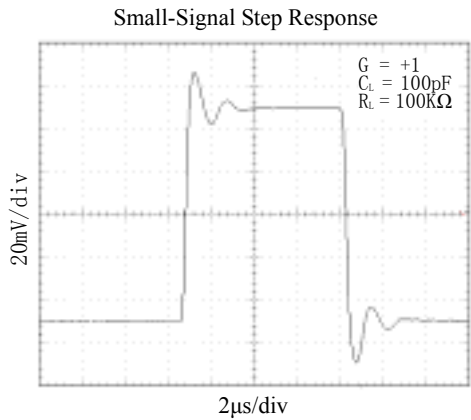
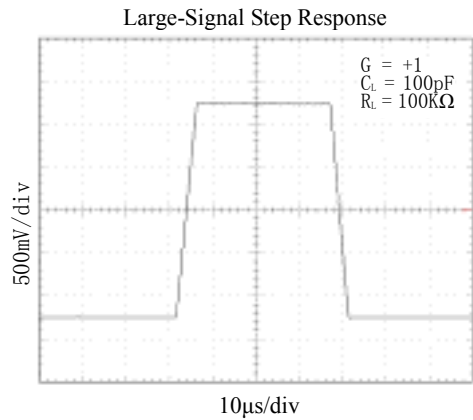
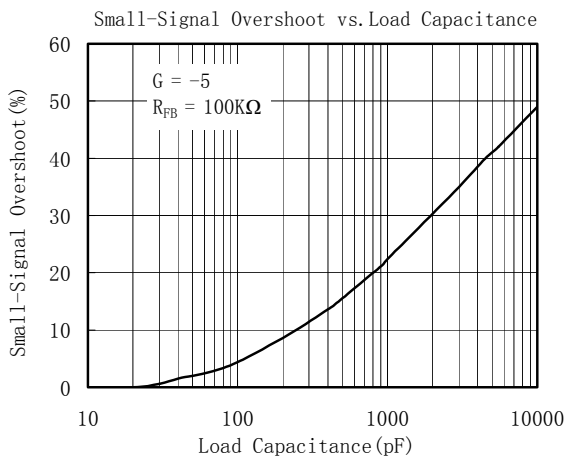
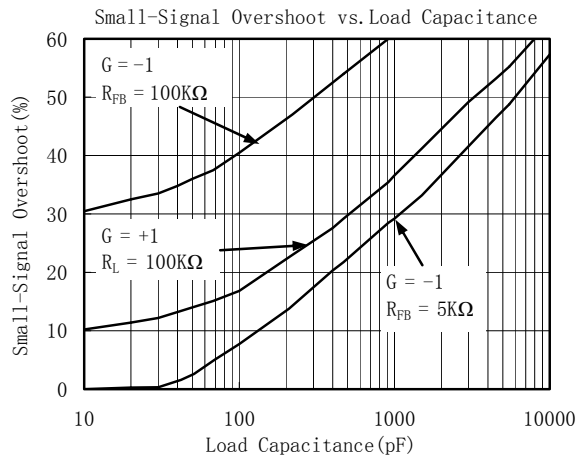
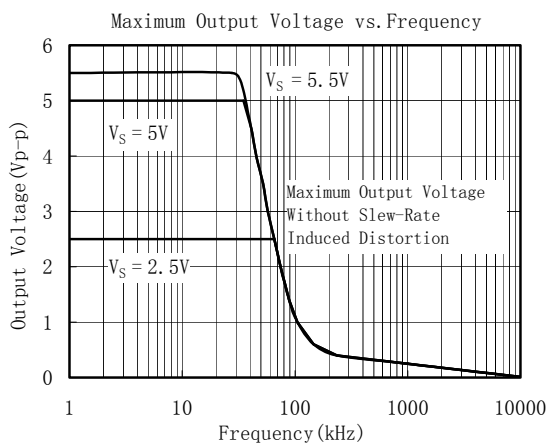
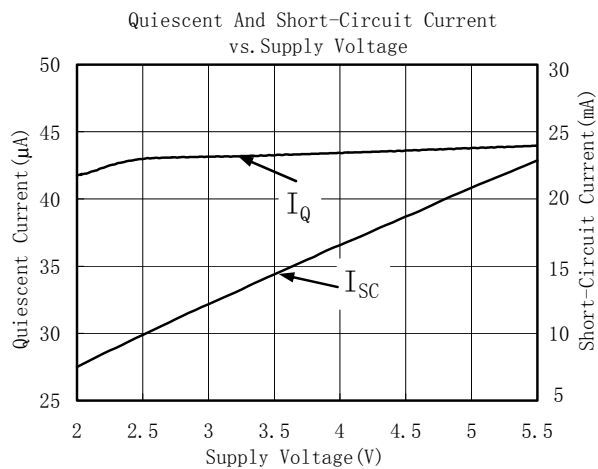
CAUTION

This integrated circuit can be damaged by ESD. Shengbang Micro-electronics recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

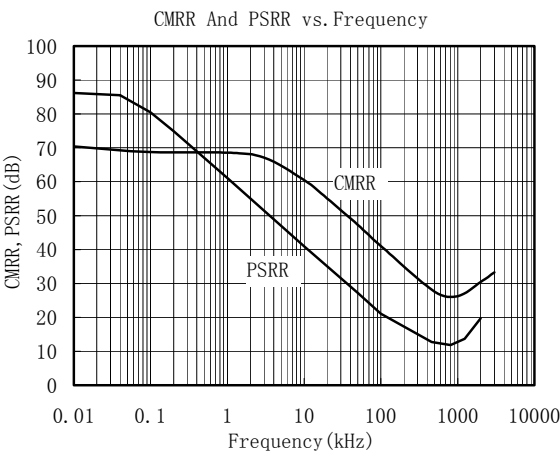
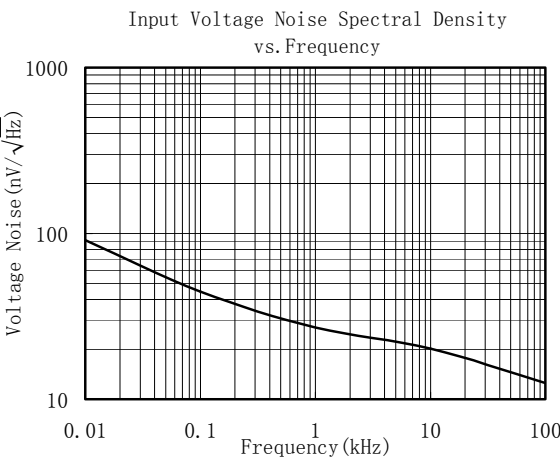
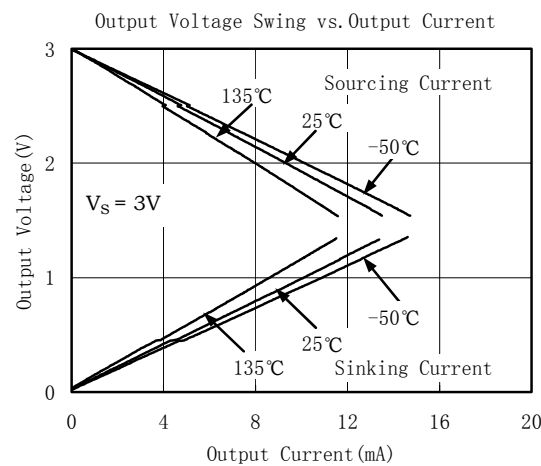
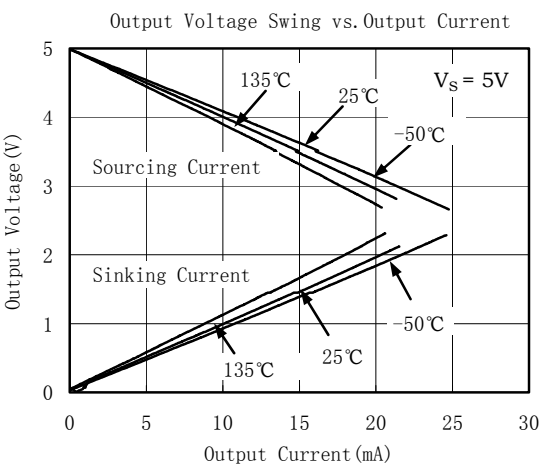
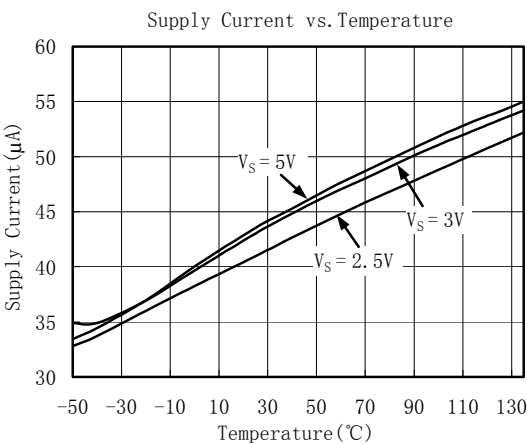
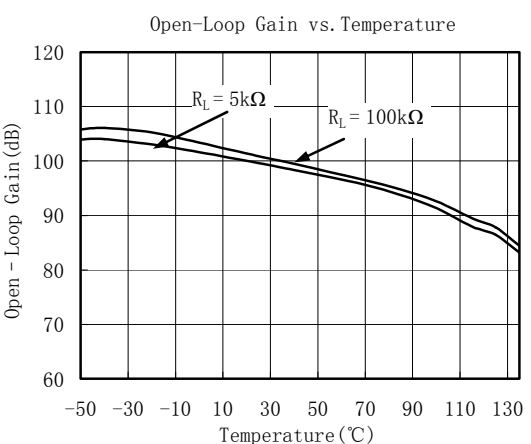
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^{\circ}\text{C}$, $V_S = +5\text{V}$, and $R_L = 100\text{k}\Omega$ connected to $V_S/2$, unless otherwise noted.



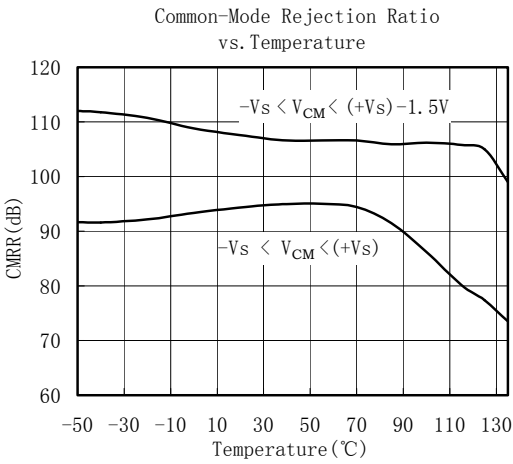
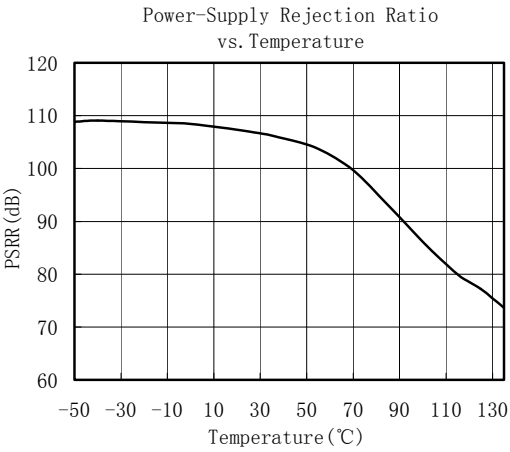
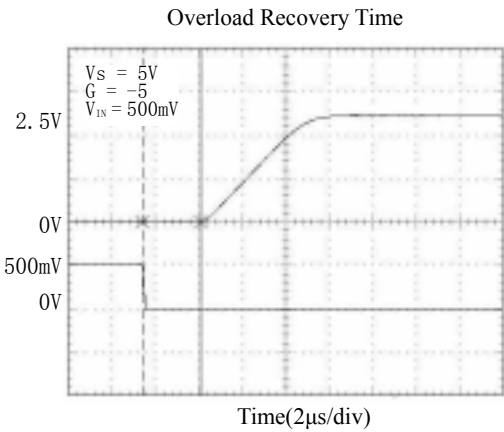
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = +5\text{V}$, and $R_L = 100\text{k}\Omega$ connected to $V_S/2$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^{\circ}\text{C}$, $V_S = +5\text{V}$, and $R_L = 100\text{k}\Omega$ connected to $V_S/2$, unless otherwise noted.



APPLICATION NOTES

Driving Capacitive Loads

The SGM3XX can directly drive 250pF in unity-gain without oscillation. The unity-gain follower (buffer) is the most sensitive configuration to capacitive loading. Direct capacitive loading reduces the phase margin of amplifiers and this results in ringing or even oscillation. Applications that require greater capacitive drive capability should use an isolation resistor between the output and the capacitive load like the circuit in Figure 1. The isolation resistor R_{ISO} and the load capacitor C_L form a zero to increase stability. The bigger the R_{ISO} resistor value, the more stable V_{OUT} will be. Note that this method results in a loss of gain accuracy because R_{ISO} forms a voltage divider with the R_{LOAD} .

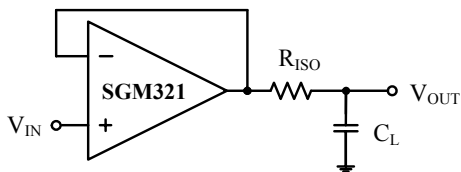


Figure 1. Indirectly Driving Heavy Capacitive Load

An improvement circuit is shown in Figure 2. It provides DC accuracy as well as AC stability. R_F provides the DC accuracy by connecting the inverting signal with the output, C_F and R_{ISO} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

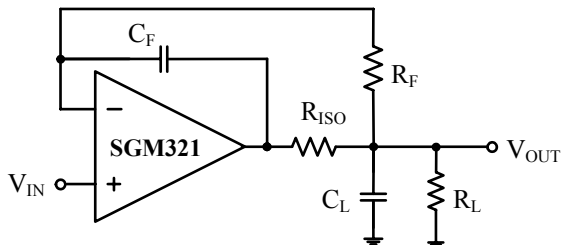


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For no-buffer configuration, there are two others ways to increase the phase margin: (a) by increasing the amplifier's gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

Power-Supply Bypassing and Layout

The SGM3XX family operates from either a single +2.5V to +5.5V supply or dual $\pm 1.25V$ to $\pm 2.75V$ supplies. For single-supply operation, bypass the power supply V_{DD} with a $0.1\mu F$ ceramic capacitor which should be placed close to the V_{DD} pin. For dual-supply operation, both the V_{DD} and the V_{SS} supplies should be bypassed to ground with separate $0.1\mu F$ ceramic capacitors. $2.2\mu F$ tantalum capacitor can be added for better performance.

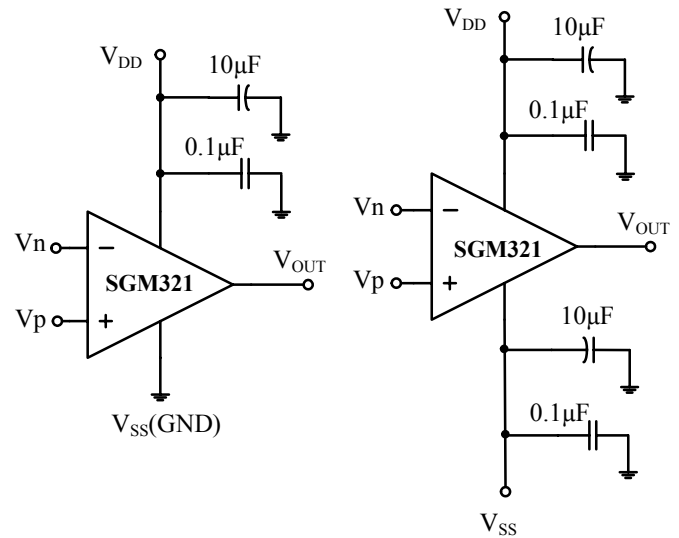


Figure 3. Amplifier with Bypass Capacitors

Typical Application Circuits

Differential Amplifier

The circuit shown in Figure 4 performs the difference function. If the resistors ratios are equal ($R_4 / R_3 = R_2 / R_1$), then $V_{OUT} = (V_p - V_n) \times R_2 / R_1 + V_{ref}$.

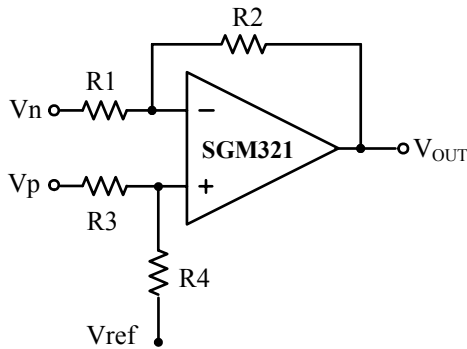


Figure 4. Differential Amplifier

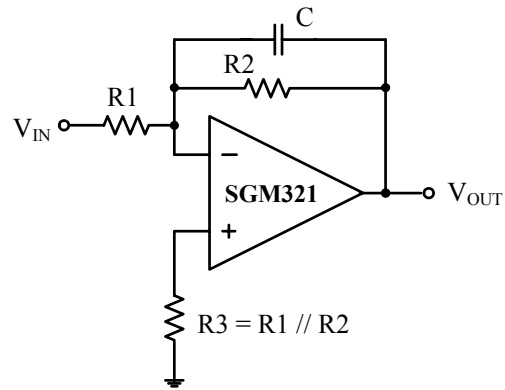


Figure 6. Low Pass Active Filter

Instrumentation Amplifier

The circuit in Figure 5 performs the same function as that in Figure 4 but with the high input impedance.

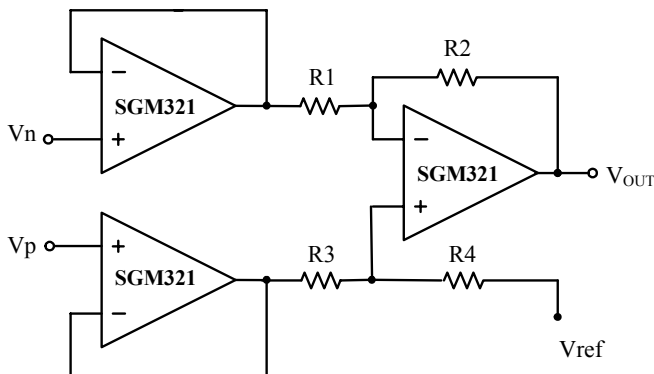


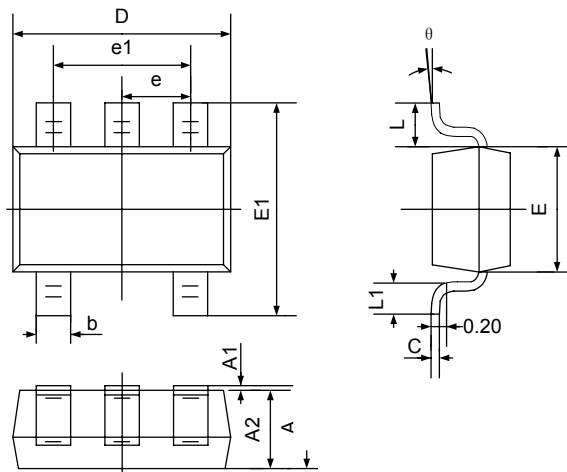
Figure 5. Instrumentation Amplifier

Low Pass Active Filter

The low pass filter shown in Figure 6 has a DC gain of ($- R_2 / R_1$) and the -3dB corner frequency is $1/2\pi R_2 C$. Make sure the filter is within the bandwidth of the amplifier. The Large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistors value as low as possible and consistent with output loading consideration.

PACKAGE OUTLINE DIMENSIONS

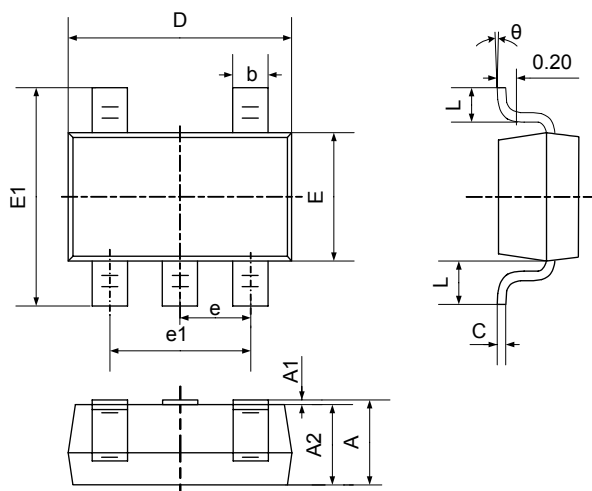
SC70-5



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

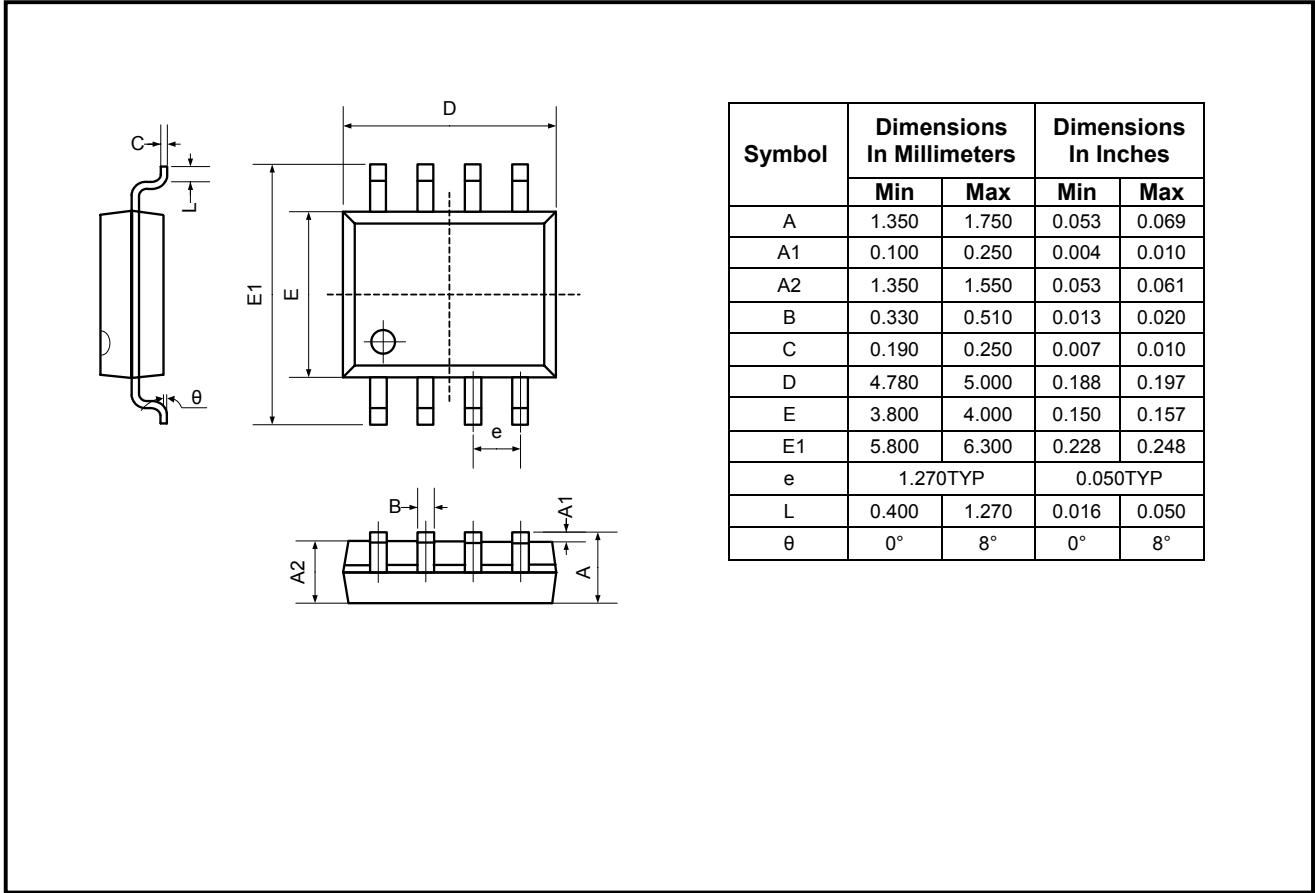
SOT23-5



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

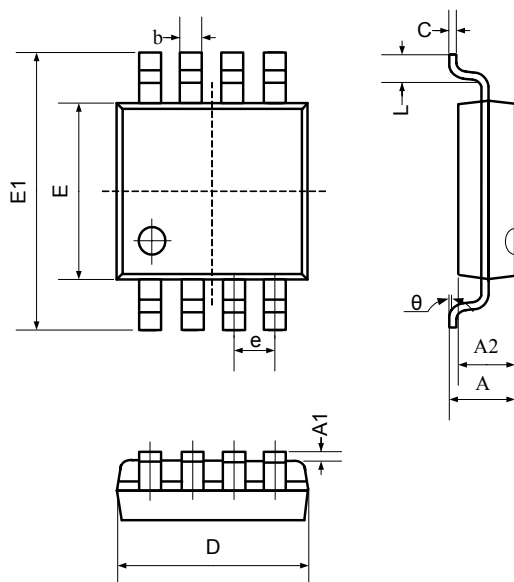
PACKAGE OUTLINE DIMENSIONS

SO-8



PACKAGE OUTLINE DIMENSIONS

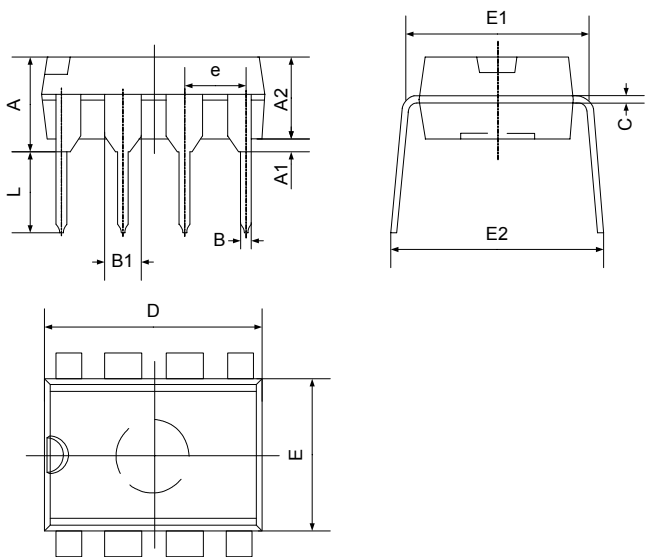
MSOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.200	0.031	0.047
A1	0.000	0.200	0.000	0.008
A2	0.760	0.970	0.030	0.038
b	0.30 TYP		0.012 TYP	
c	0.15 TYP		0.006 TYP	
D	2.900	3.100	0.114	0.122
e	0.65 TYP		0.026 TYP	
E	2.900	3.100	0.114	0.122
E1	4.700	5.100	0.185	0.201
L	0.410	0.650	0.016	0.026
θ	0°	6°	0°	6°

PACKAGE OUTLINE DIMENSIONS

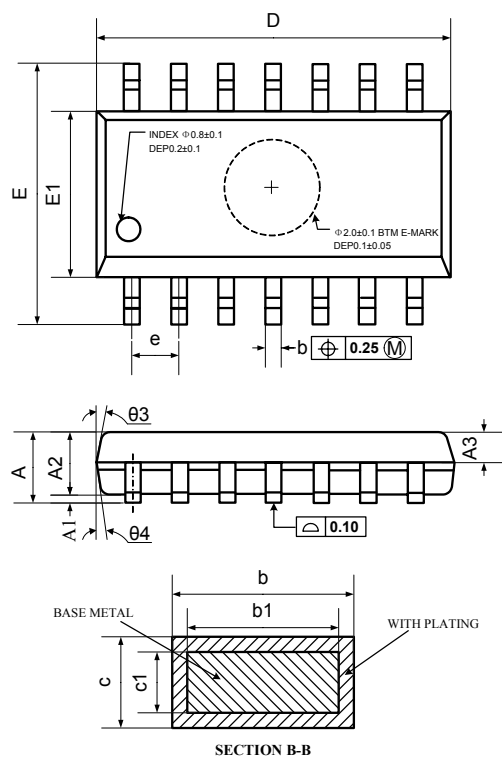
PDIP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.710	4.310	0.146	0.170
A1	0.510		0.020	
A2	3.200	3.600	0.126	0.142
B	0.380	0.570	0.015	0.022
B1	1.524(BSC)		0.060(BSC)	
C	0.204	0.360	0.008	0.014
D	9.000	9.400	0.354	0.370
E	6.200	6.600	0.244	0.260
E1	7.320	7.920	0.288	0.312
e	2.540(BSC)		0.100(BSC)	
L	3.000	3.600	0.118	0.142
E2	8.400	9.000	0.331	0.354

PACKAGE OUTLINE DIMENSIONS

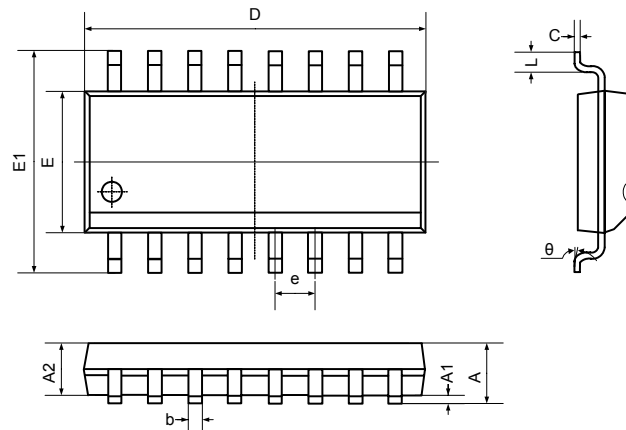
SO-14



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	1.35	1.60	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.65
A3	0.55	0.65	0.75
b	0.36		0.49
b1	0.35	0.40	0.45
c	0.16		0.25
c1	0.15	0.20	0.25
D	8.53	8.63	8.73
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27 BSC		
L	0.45	0.60	0.80
L1	1.04 REF		
L2	0.25 BSC		
R	0.07		
R1	0.07		
h	0.30	0.40	0.50
θ	0°		8°
$\theta 1$	6°	8°	10°
$\theta 2$	6°	8°	10°
$\theta 3$	5°	7°	9°
$\theta 4$	5°	7°	9°

PACKAGE OUTLINE DIMENSIONS

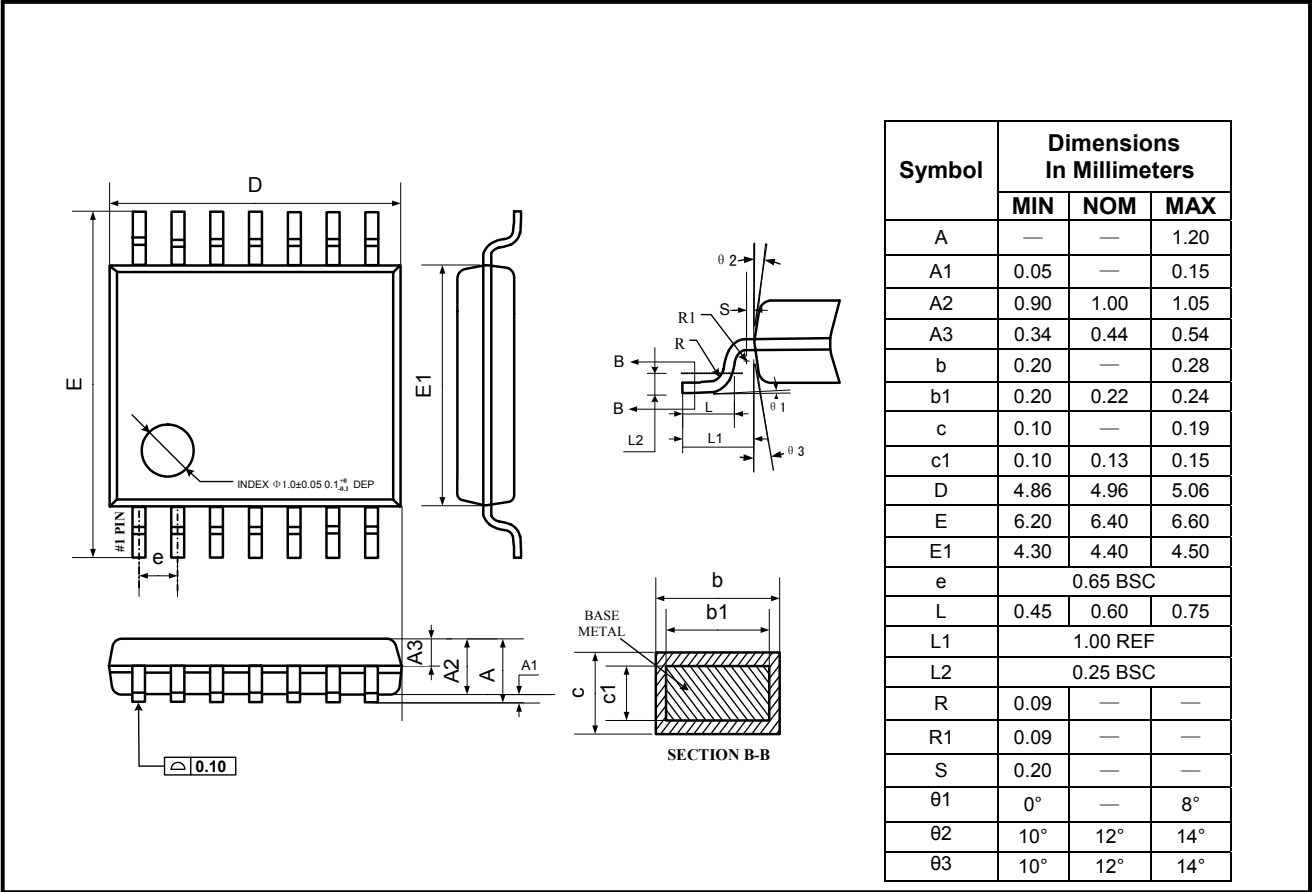
SO-16



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	9.800	10.20	0.386	0.402
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

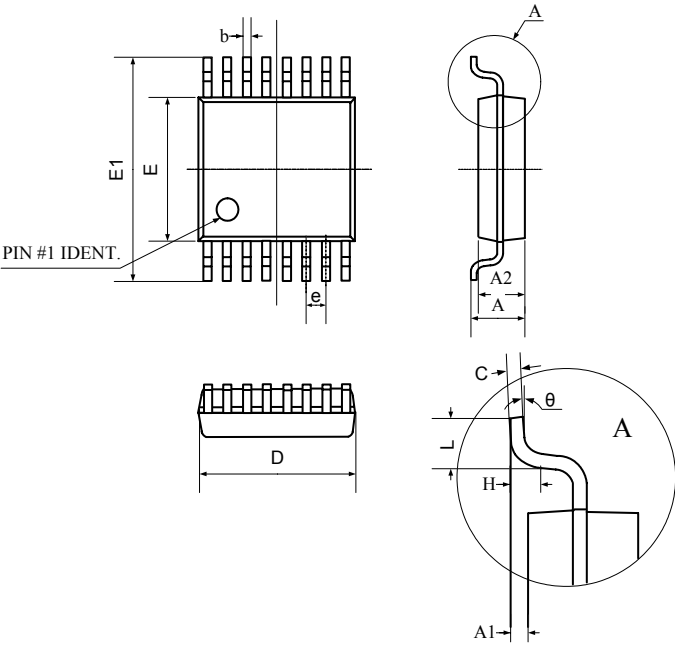
PACKAGE OUTLINE DIMENSIONS

TSSOP-14



PACKAGE OUTLINE DIMENSIONS

TSSOP-16



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
D	4.900	5.100	0.193	0.201
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.100		0.043
A2	0.800	1.000	0.031	0.039
A1	0.020	0.150	0.001	0.006
e	0.65 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

REVISION HISTORY

Location	Page
11/06— Data Sheet changed from REV.A to REV.B	
Changes to ABSOLUTE MAXIMUM RATINGS	3
04/07— Data Sheet changed from REV.B to REV.C	
Adds Output Voltage Swing from Rail test condition.	2
06/07— Data Sheet changed from REV.C to REV. D	
Adds SO-14 and TSSOP-14 Packages	1, 3, 14, 16

Shengbang Microelectronics Co, Ltd

Unit 3, ChuangYe Plaza
No.5, TaiHu Northern Street, YingBin Road Centralized Industrial Park
Harbin Development Zone
Harbin, HeiLongJiang 150078
P.R. China
Tel.: 86-451-84348461
Fax: 86-451-84308461
www.sg-micro.com